2SD1772, 2SD1772A

Silicon NPN triple diffusion planar type

For power amplification

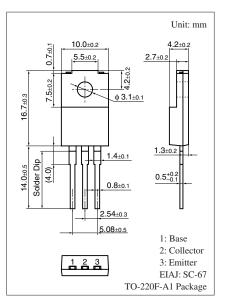
For TV vertical deflection output

Features

- \bullet Large collector power dissipation $P_{\rm C}$
- Full-pack package which can be installed to the heat sink with one screw

Parameter	Symbol	Rating	Unit	
Collector-base voltage (Er	V _{CBO}	200	V	
Collector-emitter voltage	2SD1772	V _{CEO}	150	V
(Base open)	2SD1772A		180	
Emitter-base voltage (Coll	V _{EBO}	6	V	
Collector current	I _C	1	А	
Peak collector current	I _{CP}	2	А	
Collector power dissipation		P _C	25	W
	$T_a = 25^{\circ}C$		2.0	
Junction temperature	Tj	150	°C	
Storage temperature	T _{stg}	-55 to +150	°C	

Absolute Maximum Ratings $T_C = 25^{\circ}C$



Electrical Characteristics $T_C = 25^{\circ}C \pm 3^{\circ}C$

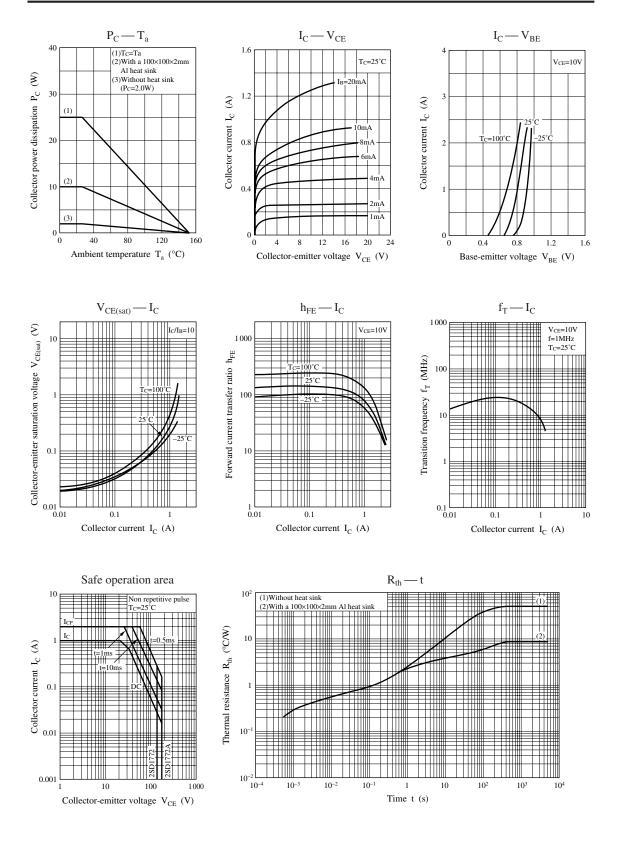
Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage	2SD1772	V _{CEO}	$I_{\rm C} = 5 {\rm mA}, I_{\rm B} = 0$	150			V
(Base open)	2SD1772A			180			
Emitter-base voltage (Colle	ctor open)	V _{EBO}	$I_{\rm E} = 0.5 \text{ mA}, I_{\rm C} = 0$	6			V
Base-emitter voltage		V _{BE}	$V_{CE} = 10 \text{ V}, I_C = 300 \text{ mA}$			1.0	V
Collector-base cutoff current (Emitter open)		I _{CBO}	$V_{CB} = 200 \text{ V}, I_E = 0$			50	μΑ
Emitter-base cutoff current (Collector open)		I _{EBO}	$V_{EB} = 4 V, I_C = 0$			50	μΑ
Forward current transfer rat	io	h _{FE1} *	$V_{CE} = 10 \text{ V}, I_{C} = 100 \text{ mA}$	60		240	_
		h _{FE2}	$V_{CE} = 10 \text{ V}, I_C = 300 \text{ mA}$	50			
Collector-emitter saturation	voltage	V _{CE(sat)}	$I_{\rm C} = 500 \text{ mA}, I_{\rm B} = 50 \text{ mA}$			1.0	V
Transition frequency		f _T	$V_{CE} = 10 \text{ V}, I_C = 0.1 \text{ A}, f = 1 \text{ MHz}$		20		MHz
Collector output capacitance		C _{ob}	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		27		pF
(Common base, input open	circuited)						

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. *: Rank classification

Rank	Q	Р		
$h_{\rm FE1}$	60 to 140	100 to 240		

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